

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S4	2	("6551906").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 13:47
S5	8	((("6551906") or ("6586315") or ("20020178883") or ("6248648"))).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 13:48
S6	7671	438/464,465,110,112,113,114,118,126,64,68,14,15.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 09:32
S10	34	wafer with thermoplastic with support	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 09:33
S11	6	S6 and (wafer with thermoplastic with support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/19 13:50
S12	7693	438/464,465,110,112,113,114,118,126,64,68,14,15.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 09:32
S13	23	S12 and (wafer with (amide epoxy imides polyimides polyesters polyuretanes thermoplastic) with support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 10:26
S14	6	S13 and (both with wafer with support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 10:27

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L1	7693	438/464,465,110,112,113,114,118,126,64,68,14,15.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 09:32
L2	23	1 and (wafer with (amide epoxy imides polyimides polyesters polyuretanes thermoplastic) with support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 10:26
L3	6	2 and (both with wafer with support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 10:27
S4	2	("6551906").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 13:47
S5	8	((("6551906") or ("6586315") or ("20020178883") or ("6248648")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/19 13:48
S6	7671	438/464,465,110,112,113,114,118,126,64,68,14,15.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 09:32
S10	34	wafer with thermoplastic with support	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 09:33
S11	6	S6 and (wafer with thermoplastic with support)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/19 13:50